



# Product Change Notification

**Change Notification #:**

**117642 - 01**

**Change Title:**

**Select Intel® SSD 660p Series Products,  
PCN 117642-01, Product Design, Label,  
Order Code**

**Firmware and Label Updates**

**Removal of select SKUs, not currently  
affected by Firmware and Product Label  
Change**

**Date of Publication:**

**June 24, 2020**

## Key Characteristics of the Change:

Product Design, Label, Order Code

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	July 6, 2020
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## Description of Change to the Customer:

**Reason for Revision: Removal of select SKUs, not currently affected by Firmware and Product Label Change**

- Select MM#'s: 999CG3, 999CG4, 976802, 976803, 976804 are not currently affected by this firmware and label change update and have been removed from this PCN, the changes for these MM#'s will happen in a future date.**

The Intel® SSD 660p Series SKUs listed in the Products Affected table below will have the firmware version updated from 002C to 004C. The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.

The product labels will be updated with new SA numbers as well as the new firmware version number:

512 GB Current



512 GB New



### 1.0 TB Current



### 1.0 TB New



### Customer Impact of Change and Recommended Action:

Since the firmware update has incremental improvement over the previous version, Intel anticipates no product impact with this firmware, and re-qualification is not recommended.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	Pre Change MM#	Pre Change TA	Pre Change SA	Post Change MM#	Post Change TA	Post Change SA
Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box Single Pack	SSDPEKNW512G8X1	978348	K10628-101	K10634-101		K10628-102	K10634-102
Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box 10 Pack	SSDPEKNW512G8XT	978349	K10629-101	K10634-101		K10629-102	K10634-102
Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box Single Pack	SSDPEKNW010T8X1	978350	K10631-101	K10635-101		K10631-102	K10635-102
Intel® SSD 660p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box Single Pack	SSDPEKNW020T8X1	978351	K10633-101	K10636-101		K10633-102	K10636-102
Intel® SSD 660p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box 10 Pack	SSDPEKNW020T8XT	984872	K31002-101	K10636-101		K31002-102	K10636-102
Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box 10 Pack	SSDPEKNW010T8XT	984875	K31001-101	K10635-101		K31001-102	K10635-102
<del>Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic 100 Pack</del>	<del>SSDPEKNW512G8</del>	<del>999CG3</del>	<del>K42147-100</del>	<del>J93121-101</del>	<del>999M0M</del>	<del>K64735-101</del>	<del>K10635-102</del>
<del>Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic 100 Pack</del>	<del>SSDPEKNW010T8</del>	<del>999CG4</del>	<del>K42149-100</del>	<del>J93130-101</del>	<del>999M5H</del>	<del>K64739-101</del>	<del>K10635-102</del>
<del>Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic Single Pack</del>	<del>SSDPEKNW512G801</del>	<del>976802</del>	<del>J93118-101</del>	<del>J93121-101</del>	<del>999M5F</del>	<del>K64738-101</del>	<del>K10635-102</del>
<del>Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic Single Pack</del>	<del>SSDPEKNW010T801</del>	<del>976803</del>	<del>J93119-101</del>	<del>J93130-101</del>	<del>999M0V</del>	<del>K64736-101</del>	<del>K10635-102</del>
<del>Intel® SSD 660p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Generic Single Pack</del>	<del>SSDPEKNW020T801</del>	<del>976804</del>	<del>J93120-101</del>	<del>J93132-101</del>	<del>976804</del>	<del>J93120-102</del>	<del>K10636-102</del>

## PCN Revision History:

### Date of Revision:

June 19, 2020

June 24, 2020

### Revision Number:

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01

### Reason:

Originally Published PCN

Removal of select SKUs, not currently affected by Firmware and Product Label Change



# Product Change Notification

## 117642 - 01

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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